

Pb Free Product NCEB301G

D2

S2 |

S2

S2

G2

Bottom View

D1

D1

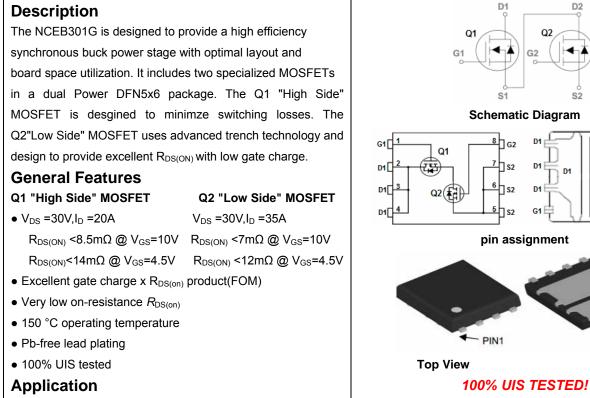
D1

G1

D1

S1/D2

30V Half Bridge Dual N-Channel Enhancement Mode Power MOSFET



• Compact DC/DC converter applications

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEB301G	NCEB301G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parame	Symbol	Q1	Q2	Unit	
Drain-Source Voltage	V _{DS}	30	30	V	
Gate-Source Voltage		V _{GS}	±20	±20	V
Drain Current-Continuous (Note 2)	T _C =25°C		20	35	А
	T _c =100°C	I _D	14.1	24.7	•
Drain Current -Pulsed (Note 1)		I _{DM}	80	120	A
Power Dissipation	T _C =25°C	PD	20	40	W
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55 To 150	-55 To 150	°C

Thermal Characteristic

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Case (Note 2) (Q1)	$R_{ extsf{ heta}JC}$	6	6.3	°C/W
Thermal Resistance, Junction-to-Case (Note 2) (Q2)	$R_{ extsf{ heta}JC}$	2.9	3.1	°C/W





NCEB301G

Q1 Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.5	2.2	V
Drain Course On Chate Desistance	D	V_{GS} =10V, I_D =10A	-	6.9	8.5	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	10.8	14	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =10A	26	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	1210	-	PF
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	160	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHZ	-	105	-	PF
Switching Characteristics (Note 4)			ł			
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V_{DD} =15V, R _L =0.75 Ω	-	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg		-	17.5		nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =10A,	-	3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	4.1		nC
Drain-Source Diode Characteristics			ł			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	20	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =10A	-	19	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	10	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25 $^\circ \!\! \mathbb{C}$,V_{DD}=15V,V_G=10V,L=0.5mH,Rg=25 Ω





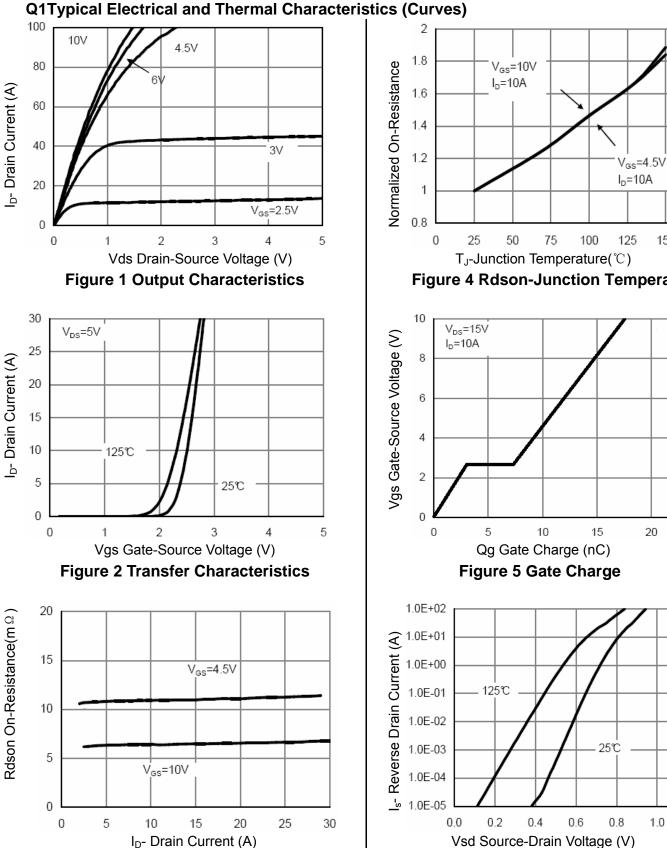


Figure 4 Rdson-Junction Temperature

150

175

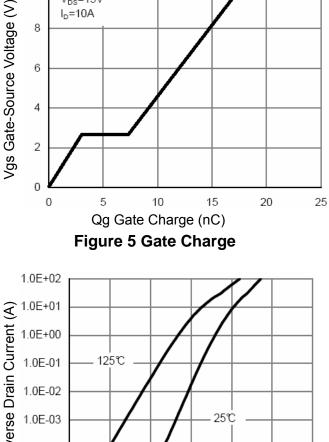


Figure 6 Source- Drain Diode Forward

Figure 3 Rdson- Drain Current

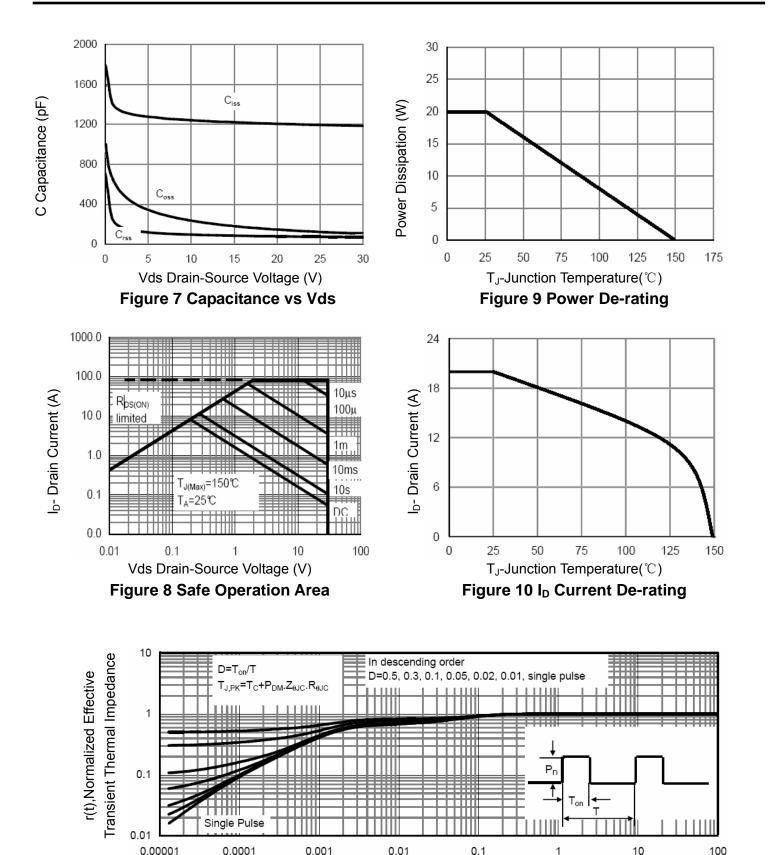
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NCEB301G

Q2 Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	· · ·		•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	33	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)			•			•	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.6	3	V	
	5	V_{GS} =10V, I _D =12A	-	5.1	7.0	- mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	8.3	12.0		
Forward Transconductance	g fs	V _{DS} =10V,I _D =12A	30	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	2330	-	PF	
Output Capacitance	C _{oss}	V_{DS} =15V, V_{GS} =0V,	-	460	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	230	-	PF	
Switching Characteristics (Note 4)			•			•	
Turn-on Delay Time	t _{d(on)}		-	18	-	nS	
Turn-on Rise Time	tr	V _{DD} =15V,I _D =12A	-	10	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =6 Ω	-	34	-	nS	
Turn-Off Fall Time	t _f		-	10	-	nS	
Total Gate Charge	Qg		-	45	-	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =12A,	-	9.4	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	7.7	-	nC	
Drain-Source Diode Characteristics	· · ·		•				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =12A	-	0.85	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	35	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 12A	-	-	47	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)	-	-	25	nC	
	~		1		=-		

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ C$,V_DD=15V,V_G=10V,L=0.5mH,Rg=25 Ω





175

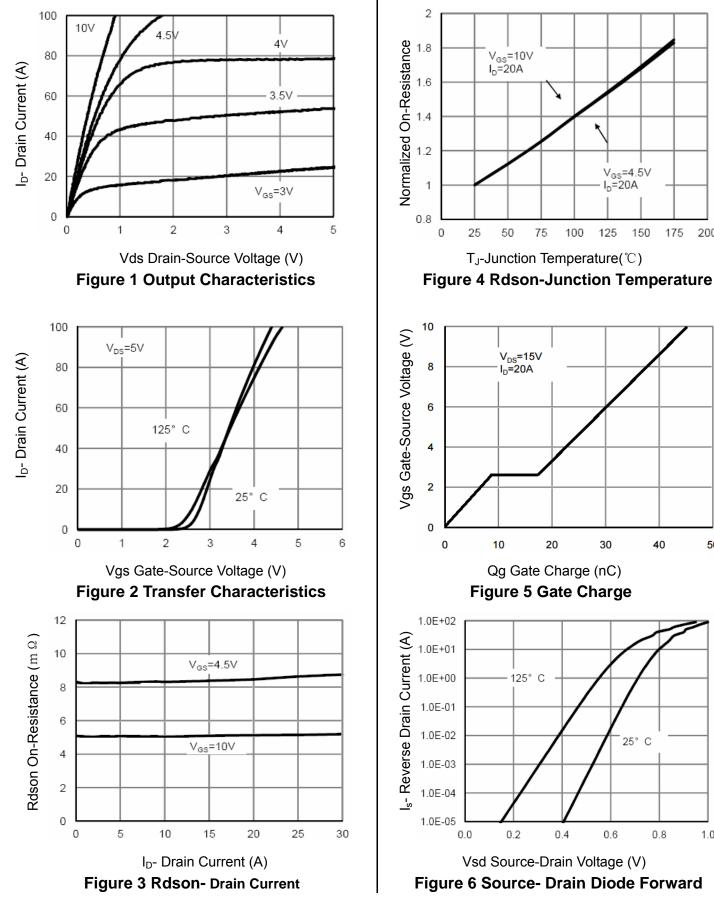
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0.8

50

200

Q2 Typical Electrical and Thermal Characteristics (Curves)

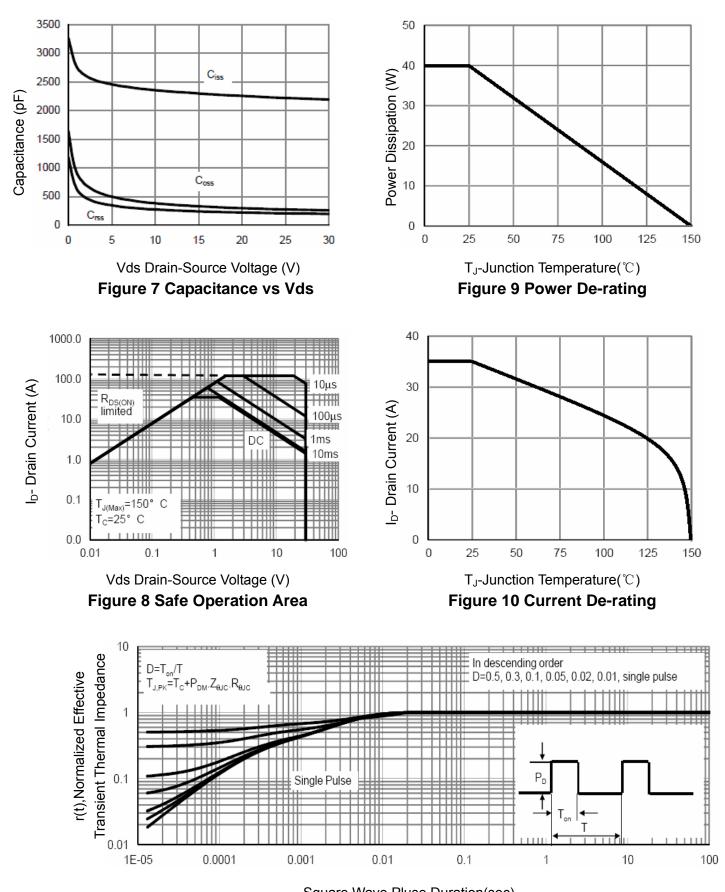


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Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

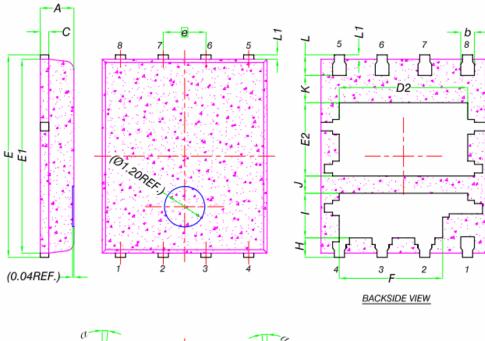


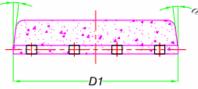
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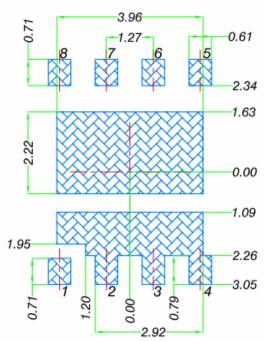
DFN5X6-8L Package Information





	MILLIMETERS					
DIM.	MIN.	NOM.	MAX.			
Α	0.90	1.00	1.10			
Ь	0.33	0.41	0.51			
С	0.20	0.25	0.30			
D1	4.80	4.90	5.00			
D2	3.61	3.81	3.96			
Е	5.90	6.00	6.10			
E1	5.70	5.75	5.80			
E2	2.02	2.02 2.17 2.3				
е	1.27 BSC					
F	2.87	3.07	3.22			
Н	0.48	0.58	0.68			
1	1.22	1.32	1.42			
J	0.40	0.50	0.60			
к	0.50	-	-			
L	0.51	0.61	0.71			
L1	0.06	0.13	0.20			
α	0°	-	12°			

Land Pattern (Only for Reference)







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